

General Description

SFGMOS[®]

DS(ON),

low gate charge, fast switching and excellent avalanche characteristics. The high V_{th} series is specially optimized for high systems with gate driving voltage greater than 10V.

Features

- Low $R_{DS(ON)}$ & FOM
- Extremely low switching loss
- Excellent stability and uniformity
- Fast switching and soft recovery



Applications

- Switched mode power supply
- Motor driver
- Battery protection
- DC-DC convertor
- Solar inverter
- UPS and energy inverter

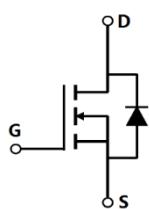
Key Performance Parameters

| Parameter | Value | Unit |
|--------------------------------|-------|------|
| $V_{DS, min} @ T_{j(max)}$ | 100 | V |
| $I_D, pulse$ | 540 | A |
| $R_{DS(ON), max} @ V_{GS}=10V$ | 3 | |
| Q_g | 158.8 | nC |

Marking Information

| Product Name | Package | Marking |
|--------------|---------|------------|
| SFG180N10KF | TO263 | SFG180N10K |

Package & Pin information



Absolute Maximum Ratings at $T_j=25^\circ\text{C}$ unless otherwise noted

| Parameter | Symbol | Value | Unit |
|---|----------------------------|------------|------------------|
| Drain source voltage | V_{DS} | 100 | V |
| Gate source voltage | V_{GS} | ± 20 | V |
| Continuous drain current ¹⁾ , $T_C=25^\circ\text{C}$ | I_D | 180 | A |
| Pulsed drain current ²⁾ , $T_C=25^\circ\text{C}$ | $I_{D,\text{pulse}}$ | 540 | A |
| Continuous diode forward current ¹⁾ , $T_C=25^\circ\text{C}$ | I_S | 180 | A |
| Diode pulsed current ²⁾ , $T_C=25^\circ\text{C}$ | $I_{S,\text{pulse}}$ | 540 | A |
| Power dissipation ³⁾ , $T_C=25^\circ\text{C}$ | P_D | 375 | W |
| Single pulsed avalanche energy ⁵⁾ | E_{AS} | 1000 | mJ |
| Operation and storage temperature | $T_{\text{stg}} \quad T_j$ | -55 to 150 | $^\circ\text{C}$ |

Thermal Characteristics

| Parameter | Symbol | Value | Unit |
|--|--------|-------|---------------------------|
| Thermal resistance, junction-case | R | 0.33 | $^\circ\text{C}/\text{W}$ |
| Thermal resistance, junction-ambient ⁴⁾ | R | 62 | $^\circ\text{C}/\text{W}$ |

Electrical Characteristics at $T_j=25^\circ\text{C}$ unless otherwise specified

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Test condition |
|----------------------------------|---------------------|------|------|------|------|---|
| Drain-source breakdown voltage | BV_{DSS} | 100 | | | V | $V_{GS}=0 \text{ V}, I_D=250 \text{ A}$ |
| Gate threshold voltage | $V_{GS(\text{th})}$ | 2.0 | | 4.0 | V | $V_{DS}=V_{GS}, I_D=250 \text{ A}$ |
| Drain-source on-state resistance | $R_{DS(\text{ON})}$ | | 2.5 | 3.0 | | $V_{GS}=10 \text{ V}, I_D=20 \text{ A}$ |
| Gate-source leakage current | I_{GSS} | | | 100 | nA | $V_{GS}=20 \text{ V}$ |
| Drain-source leakage current | | | | -100 | | $V_{GS}=-20 \text{ V}$ |
| | I_{DSS} | | 1 | A | | |

Dynamic Characteristics

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Test condition |
|------------------------------|---------------------|------|-------|------|------|---|
| Input capacitance | C _{iss} | | 10953 | | pF | V _{GS} =0 V, V _{DS} =50 V, 100 kHz |
| Output capacitance | C _{oss} | | 1402 | | pF | |
| Reverse transfer capacitance | C _{rss} | | 33.3 | | pF | |
| Turn-on delay time | t _{d(on)} | | 40.7 | | ns | V _{GS} =10 V, V _{DS} =50 V, R _G =2.2 I _D =25 A |
| Rise time | t _r | | 31.4 | | ns | |
| Turn-off delay time | t _{d(off)} | | 75.4 | | ns | |
| Fall time | t _f | | 16.2 | | ns | |

Gate Charge Characteristics

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Test condition |
|--------------------|-----------------|------|-------|------|------|--|
| Total gate charge | Q _g | | 158.8 | | nC | V _{GS} =10 V, V _{DS} =50 V, I _D =25 A |
| Gate-source charge | Q _{gs} | | 38.4 | | nC | |

Gate-

Electrical Characteristics Diagrams

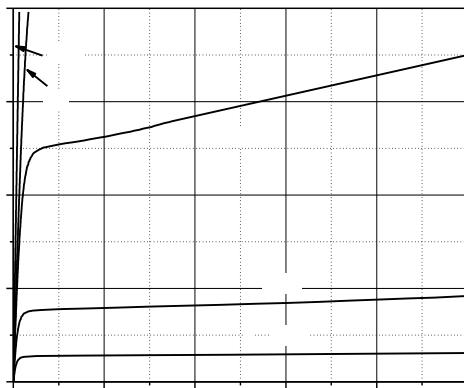


Figure 1. Typ. output characteristics

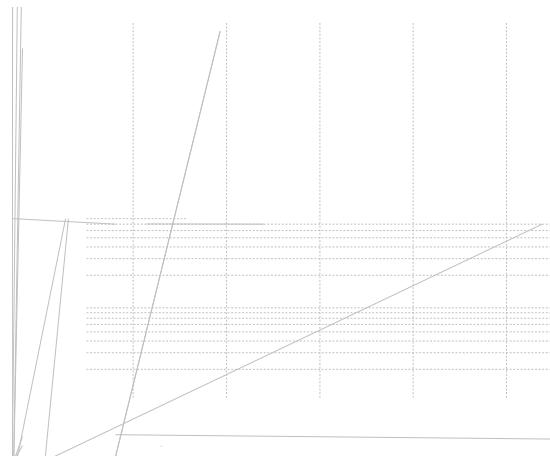


Figure 2. Typ. transfer characteristics

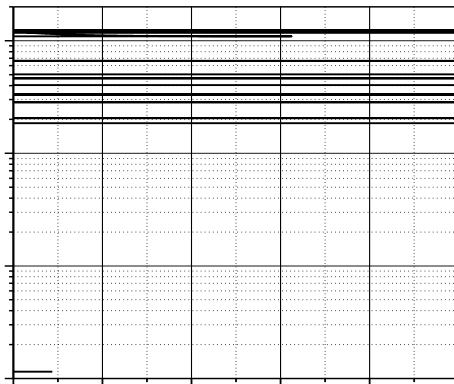


Figure 3. Typ. capacitances



Figure 4. Typ. gate charge

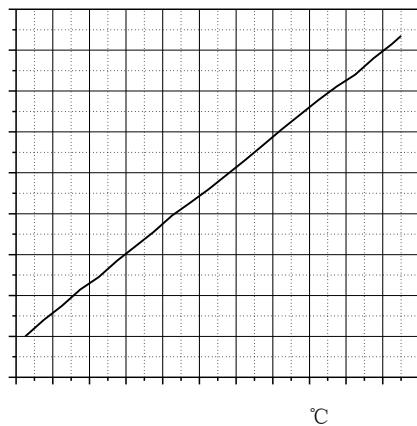


Figure 5. Drain-source breakdown voltage

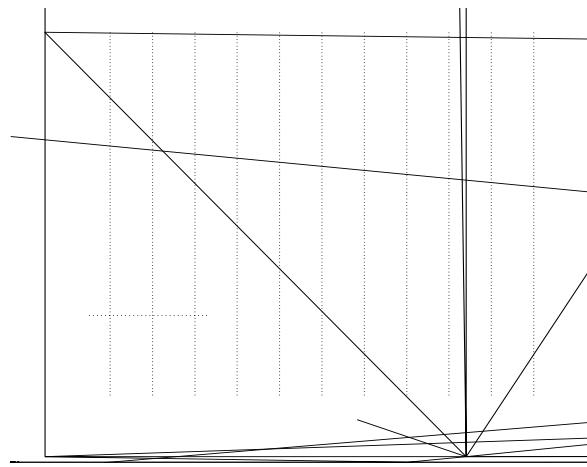
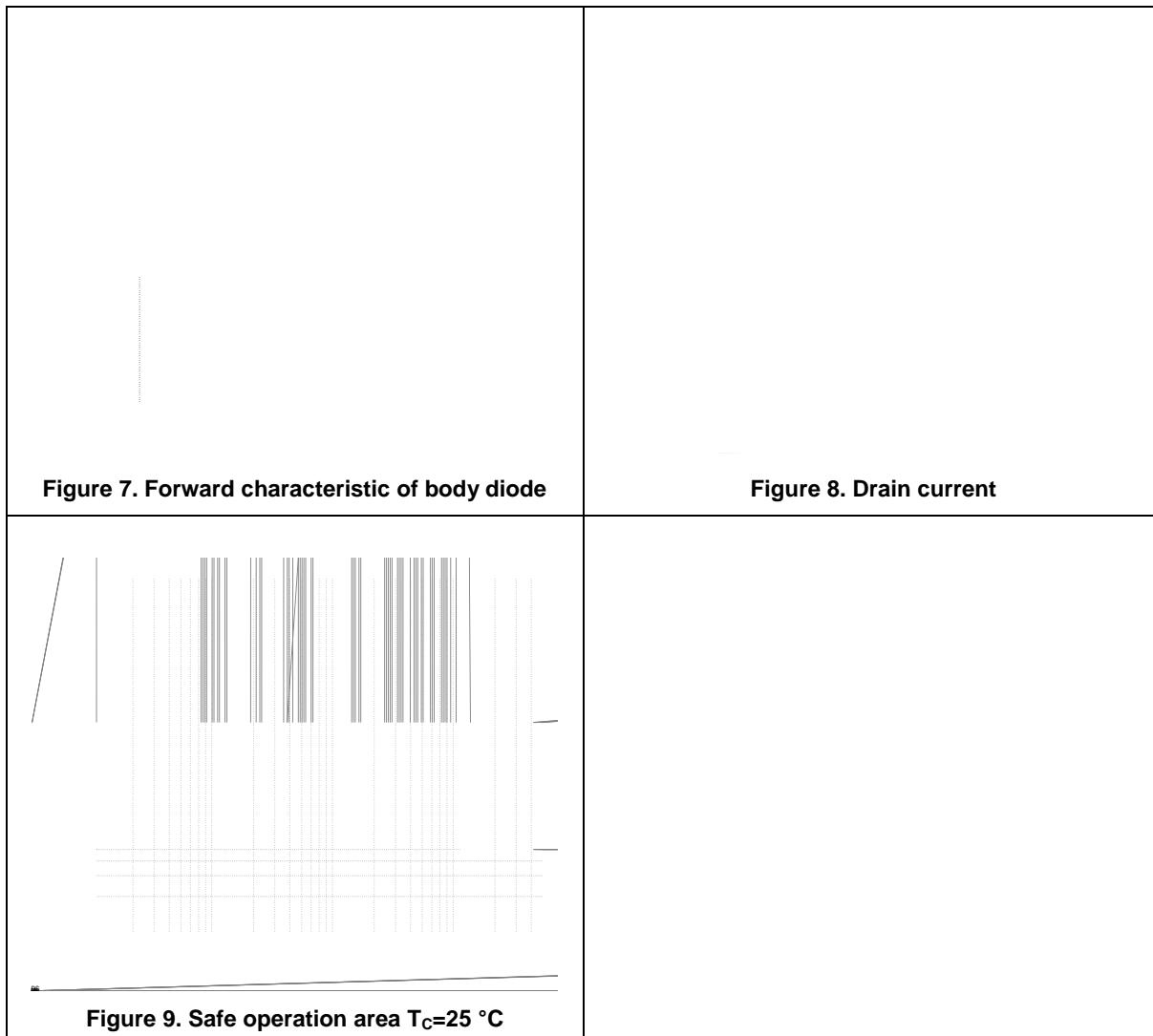
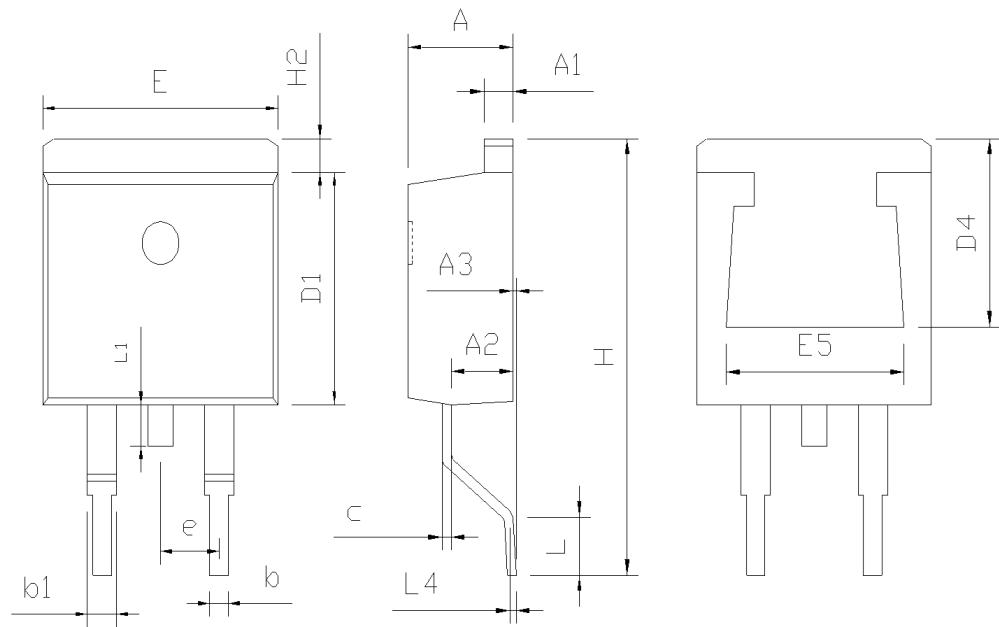


Figure 6. Drain-source on-state resistance



Package Information



| Symbol | mm | | |
|--------|----------|-------|-------|
| | Min | Nom | Max |
| A | 4.37 | 4.57 | 4.77 |
| A1 | 1.22 | 1.27 | 1.42 |
| A2 | 2.49 | 2.69 | 2.89 |
| A3 | 0.00 | 0.13 | 0.25 |
| b | 0.70 | 0.81 | 0.96 |
| b1 | 0.17 | 1.27 | 1.47 |
| c | 0.30 | 0.38 | 0.53 |
| D1 | 8.50 | 8.70 | 8.90 |
| D4 | 6.60 | - | - |
| E | 9.86 | 10.16 | 10.36 |
| E5 | 7.06 | - | - |
| e | 2.54 BSC | | |
| H | 14.70 | 15.10 | 15.50 |
| H2 | 1.07 | 1.27 | 1.47 |
| L2 | 2.00 | 2.30 | 2.60 |
| L1 | 1.40 | 1.55 | 1.70 |
| L4 | 0.25 BSC | | |

Version 1: TO263-C package outline dimension

Ordering Information

| Package Type | Units/Reel | Reels / Inner Box | Units/Inner Box | Inner Boxes/Carton Box | Units/Carton Box |
|--------------|------------|-------------------|-----------------|------------------------|------------------|
| TO263-C | 800 | 1 | 800 | 5 | 4000 |

Product Information

| Product | Package | Pb Free | RoHS | Halogen Free |
|-------------|---------|---------|------|--------------|
| SFG180N10KF | TO263 | yes | yes | yes |

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